

Structural Epoxy Adhesive

Description

9200 is a toughened, two-part epoxy adhesive, designed to create long-lasting load-bearing joints. It adheres strongly to a wide range of materials that are difficult to bond to, including glass, ceramics, metals, engineered thermoplastics, and thermoset laminates, such as SMC (sheet molding compound) and GRP (glass-reinforced plastics). It creates tough vibration-resistant bonds, and is especially useful for joining dissimilar materials that will experience thermal cycling stresses.

This product also provides excellent electrical insulation, and protects against static discharges, thermal shocks, galvanic corrosion, environmental humidity, salt water, fungus, and many harsh chemicals.

It is smooth, non-sagging and thixotropic, so it is excellent for use on vertical surfaces and for gap filling. It is also useful for potting electronics in enclosures with gaps where a non-thixotropic encapsulant would flow through.

For a flame retardant version, use 9200FR.

Features and Benefits

- *1:1 mix ratio*
- *Excellent bond strength to a wide variety of substrates*
- *Extreme resistance to vibration and temperature cycling*
- *Superior tensile, compressive and lap shear strength*
- *Excellent chemical resistance*
- *Excellent electrical insulating characteristics*
- *Non-sagging and gap-filling*
- *Ideal for bonding dissimilar materials*
- *Low shrinkage*
- *RoHS 3 compliant*

Usage Parameters

Properties	Value
Working life @22 °C [72 °F]	30 min
Shelf life @22 °C [72 °F] ^{a)}	≥3 y
Full cure @22 °C [72 °F]	48 h
Full cure @40 °C [104 °F]	16 h
Full cure @65 °C [149 °F]	1.5 h
Full cure @80 °C [176 °F]	1 h
Full cure @100 °C [212 °F]	15 min

Temperature Ranges

Properties	Value
Constant service temperature	-40 to 150 °C [-40 to 302 °F]
Storage temperature	16 to 27 °C [61 to 81 °F]

Cured Properties

Physical Properties	Method	Value ^{a)}
Color	Visual	Yellowish grey
Density @26 °C [79 °F]	ASTM D 1475	1.23 g/mL
Hardness	Shore D Durometer	76D
Tensile strength	ASTM D 638	16 N/mm ² [2 400 lb/in ²]
Compressive strength	ASTM D 695	64 N/mm ² [9 300 lb/in ²]
Lap shear strength (stainless steel)	ASTM D 1002	20 N/mm ² [2 900 lb/in ²]
Lap shear strength (aluminum)	ASTM D 1002	22 N/mm ² [3 200 lb/in ²]
Lap shear strength (copper)	ASTM D 1002	18 N/mm ² [2 700 lb/in ²]
Lap shear strength (brass)	ASTM D 1002	19 N/mm ² [2 800 lb/in ²]
Lap shear strength (polycarbonate)	ASTM D 1002	3.5 N/mm ² [500 lb/in ²]
Lap shear strength (ABS)	ASTM D 1002	3.4 N/mm ² [500 lb/in ²]

Note: Specifications are for epoxy samples cured at 40 °C for 16 h and conditioned at ambient temperature and humidity.

a) N/mm² = mPa; lb/in² = psi

Cured Properties

Electrical Properties	Method	Value
Breakdown voltage @2.5 mm	ASTM D 149	41 500 V [41.5 kV]
Dielectric strength @2.5 mm	ASTM D 149	503 V/mil [19.8 kV/mm]
Breakdown voltage @3.175 mm [1/8"]	Reference fit ^{a)}	51 000 V [51 kV]
Dielectric strength @3.175 mm [1/8"]	Reference fit ^{a)}	408 V/mil [16.1 kV/mm]
Volume resistivity	ASTM D 257	$2.5 \times 10^{13} \Omega \cdot \text{cm}$
Volume conductivity	ASTM D 257	$4 \times 10^{-14} \text{ S/cm}$
Thermal Properties	Method	Value
Glass transition temperature (T_g)	ASTM E 3418	44 °C [111 °F]
CTE ^{b)} prior T_g after T_g	ASTM E 831 ASTM E 831	95 ppm/°C [203 ppm/°F] 215 ppm/°C [419 ppm/°F]
Thermal conductivity @25 °C [77 °F]	ASTM E 1461 92	0.3 W/(m·K)
Thermal diffusivity @25 °C [77 °F]	ASTM E 1461 92	0.2 mm ² /s
Specific heat capacity @25 °C [77 °F]	ASTM E 1461 92	1.4 J/(g·K)

Note: Specifications are for epoxy samples cured at 40 °C for 16 h and conditioned at ambient temperature and humidity.

a) To allow comparison between products, the dielectric strength was recalculated with the Tautscher equation fitted to 5 experimental values and extrapolated to a standard thickness of 1/8" (3.175 mm).

b) Coefficient of Thermal Expansion (CTE) units are in ppm/°C = in/in/°C × 10⁻⁶ = unit/unit/°C × 10⁻⁶

Uncured Properties

Physical Properties	Mixture (A:B)
Color	Yellowish grey
Density	1.25 g/mL
Mix ratio by volume	1:1
Mix ratio by weight	1:1

Physical Properties	Part A	Part B
Color	Light grey	Cream yellow
Density	1.25 g/mL	1.25 g/mL
Odor	Mild	Ammonia-like

Compatibility

Adhesion—9200 epoxy adheres to most plastics and metals used to house printed circuit assemblies; however, it is not compatible with contaminants like water, oil, or greasy flux residues, which may affect adhesion. In case of contamination, first clean the surface to be coated with MG Chemicals 824 Isopropyl Alcohol.

For substrate substances with weak adhesion strengths, surface preparation such as sanding or pre-coating with a suitable primer may improve adhesion.


Chemical resistance—Once cured, the epoxy adhesive is inert under normal conditions. It will resist water and salt exposure.

It is expected to resist short term exposures to fuels or similar non-polar organic solvents, but it is not suitable for prolonged exposures. Avoid use with strong acids, strong bases, or strong oxidizers.

Storage

Store between 16 to 27 °C [61 to 81 °F] in a dry area, away from sunlight. Some of the components are sensitive to air, always recap firmly when not in use to maximize shelf life.

Substrate Adhesion (In Decreasing Order)

Physical Properties	Adhesion	
Aluminum	Stronger	
Steel		
Copper/brass		
Fiberglass		
Wood		
Paper, Fiber		
Glass		
Rubber		
Polycarbonate		
Acrylic		Weaker
Polypropylene		Does not bond

Health and Safety

Please see the 9200 Safety Data Sheet (SDS) parts A and B for further details on transportation, storage, handling, safety guidelines, and regulatory compliance.

Application Instructions

For best results, follow the procedure below. Heat cure to achieve optimal conductivity.

Syringe or cartridge:

To insert the cartridge in the gun, see the Application Guide section for dispensing accessories.

1. Twist and remove the cap from the cartridge or syringe. Do not discard cap.
2. Dispense a small amount to ensure even flow of both parts.
3. (Optional) Attach a static mixer to the 9200-50ML.
 - a. Dispense and discard 3 to 5 mL of the product to ensure a homogeneous mixture.
 - b. After use, dispose of static mixer.
4. Without a static mixer, dispense material on a mixing surface or container, and thoroughly mix parts A and B together.
5. To stop the flow, pull back on the plunger.
6. Clean nozzle to prevent contamination and material buildup.
7. Replace the cap on the cartridge or syringe.

Cure Instructions

Room temperature cure:

- Let cure at room temperature for 48 h.

Heat cure:

- Put in oven at 40 °C [104 °F] for 16 h.
—OR—
- Put in oven at 65 °C [149 °F] for 1.5 h.
—OR—
- Put in oven at 80 °C [176 °F] for 1 h.
—OR—
- Put in oven at 100 °C [176 °F] for 15 min.

Dispensing Accessories

Consult the table below for appropriate accessory selection. See the [Application Guide](#) for instructions on using the dispensing accessories.

Cat. No.	Dispensing Gun	Static Mixer
9200-25ML	N/A	N/A
9200-50ML	8DG-50-1-1	8MT-50, 8MT-50FT

Packaging and Supporting Products

Cat. No.	Packaging	Net Volume	Net Weight	Packaged Weight
9200-25ML	Dual syringe	25 mL [0.84 fl oz]	31.3 g [1 oz]	85 g [0.19 lb]
9200-50ML	Dual cartridge	45 mL [1.52 fl oz]	56.3 g [1.81 oz]	103 g [0.23 lb]

Technical Support

Please contact us regarding any questions, suggestions for improvements, or problems with this product. Application notes, instructions and FAQs are located at www.mgchemicals.com.

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